



STIC Search Report

EIC 1700

STIC Database Tracking Number: 177776

TO: Kuo-Liang Peng
Location: REM 10A71
Art Unit : 1712
April 25, 2006

Case Serial Number: 10/691433

From: Mrs. Kendra Banks
Location: EIC 1700
REMSEN 4B28
Phone: 571/272-2516
Kendra.Banks@uspto.gov

Search Notes

No Cases Reported

US 6,306,966



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 United States Patent and Trademark Office
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 Alexandria, Virginia 22313-1450
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CONFIRMATION NO. 2140

Bib Data Sheet

SERIAL NUMBER 10/691,433	FILING DATE 10/23/2003	CLASS 525	GROUP ART UNIT 1712	ATTORNEY DOCKET NO. 2003_1406
	RULE			

APPLICANTS

Yasunobu Horie, Tokyo, JAPAN;

Yoshinobu Egawa, Kanagawa-ken, JAPAN;
 Yuichi Oshima, Tokyo, JAPAN; Hideharu Hashimukai, Tokyo, JAPAN;
 Tomokazu Wakaume, Tokyo, JAPAN;
 Hiroshi Aoki, Tokyo, JAPAN;

** CONTINUING DATA *****

This application is a REI of 09/422,084 10/21/1999 PAT 6,306,966

*Please go to the
list given in the
sheet.*

*Kuo-Liang Peng
REI 10/21/1999
(2-10-91)*

** FOREIGN APPLICATIONS *****

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

** 05/10/2004

Foreign Priority claimed	<input type="checkbox"/> yes <input type="checkbox"/> no	STATE OR COUNTRY	SHEETS	TOTAL	INDEPENDENT
35 USC 119 (a-d) conditions met	<input type="checkbox"/> yes <input type="checkbox"/> no <input checked="" type="checkbox"/> Met after Allowance	JAPAN	DRAWING	CLAIMS 20	CLAIMS 3
Verified and Acknowledged	Examiner's Signature _____ Initials _____				

ADDRESS

00513
 WENDEROTH, LIND & PONACK, L.L.P.
 2033 K STREET N. W.
 SUITE 800
 WASHINGTON , DC
 20006-1021

TITLE

Moisture curable composition

 All Fees 1.16 Fees (Filing)

Current session 20/01/2006

(C) QUESTEL 1994

QUESTEL.ORBIT (TM) 1998

20/01/06 21*51*20

Last connection: 18/01/06 13*35*14

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Query/Command : FILE PLUSPAT

QUESTEL - Time in minutes : 0,58
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Estimated cost : 0.65 USD
Cost estimated for the last database search : 0.65 USD
Estimated total session cost : 0.65 USD

Selected file: PLUSPAT

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Last update of file: 2006/01/18 (YYYY/MM/DD) 2006-02/UP (last update)

Search statement 1

Query/Command : US6306966/PN

** SS 1: Results 1

Search statement 2

Query/Command : PRT FULL NONSTOP LEGALALL

1/1 PLUSPAT - ©QUESTEL-ORBIT

PN - US6306966 B1 20011023 [US6306966]

TI - (B1) Moisture curable composition
PA - (B1) CEMEDINE CO LTD (US)
PA0 - Cemedine Company, Ltd., Tokyo [JP]
IN - (B1) HASHIMUKAI HIDEHARU (JP); OSHIMA YUICHI (JP); AOKI HIROSHI (JP); EGAWA YOSHINOBU (JP); HORIE YASUNOBU (JP); WAKAUME TOMOKAZU (JP)
AP - US42208499 19991021 [1999US-0422084]
PR - US42208499 19991021 [1999US-0422084]
AU5598999 19991021 [1999AU-0055989]
CA2287622 19991025 [1999CA-2287622]
EP99121261 19991025 [1999EP-0121261]
JP11674898 19980427 [1998JP-0116748]
IC - (B1) C08L-071/02
EC - C08G-065/336
C08L-043/04 &B4
C08L-071/02 &B2
PCL - ORIGINAL (O) : 525106000; CROSS-REFERENCE (X) : 524493000
525404000 528901000
DT - Corresponding document
CT - US5109064; EP0339666 A2; EP0525769 A1; EP0541074 A2
Kroshwitz, Encyclopedia of Chemical Technology, 4th Ed., vol. 21, Wiley-Interscience, p. 1023.
STG - (B1) U.S. Patent (no pre-grant pub.) after Jan. 2, 2001
AB - A moisture curable composition excellent in transparency, operating efficiency and storage stability, and is suitable for use as an adhesive and a sealing material is provided. The moisture curable composition produced by blending 100 parts by weight of a mixture (A) and 2 parts by weight to 300 parts by weight of amorphous powder (B). The mixture (A) comprises (1) a copolymer having reactive silicon groups which can be cross-linked by hydrolysis, whose molecular chain substantially consists of (i) alkylacrylate and/or alkylmethacrylate monomeric units having an alkyl group with 1 to 8 carbon atoms, and (ii) alkylacrylate and/or alkylmethacrylate monomeric units having an alkyl group with 10 or more carbon atoms, and (2) a polymer substantially consisting of oxyalkylene including reactive silicon groups which can be cross-linked by hydrolysis. The amorphous powder (B) has a grain diameter ranging from 0.01 MU m to 300 MU m.
UP - 2001-44

1/1 LGST - ©EPO

PN - US6306966 B1 20011023 [US6306966]
AP - US42208499 19991021 [1999US-0422084]
ACT - 19991021 US/AS-A
ASSIGNMENT
OWNER: CEMEDINE CO., LTD. 5-9, HIGASHIGOTANDA 4-CHOME SHI
ASSIGNMENT OF ASSIGNORS INTEREST;ASSIGNORS:HORIE,
YASUNOBU;EGAWA, YOSHINOBU;OSHIMA, YUICHI;AND

OTHERS;REEL/FRAME:010338/0459;SIGNING DATES FROM 19991012 TO
19991014

20040615 US/RF-A
REISSUE APPLICATION FILED
EFFECTIVE DATE: 20031023

UP - 2004-26

/// CRXX - ©CLAIMS/RRX

PN - 6,306,966 A 20011023 [US6306966]

PA - Cemedine Co Ltd JP

ACT - 20031023 REISSUE REQUESTED

ISSUE DATE OF O.G.: 20040615

REISSUE REQUEST NUMBER: 10/691433

EXAMINATION GROUP RESPONSIBLE FOR REISSUEPROCESS: 1712

Reissue Patent Number:

Search statement 2

Query/Command : FILE INPADOC

LGST - Time in minutes : 0,04
The cost estimation below is based on Questel's
standard price list

Estimated cost : 0.05 USD
Records displayed and billed : 1
Estimated cost : 0.68 USD
Cost estimated for the last database search : 0.73 USD
Estimated total session cost : 1.38 USD

CRXX - Time in minutes : 0,07
The cost estimation below is based on Questel's
standard price list

Estimated cost : 0.13 USD
Records displayed and billed : 1
Estimated cost : 5.80 USD
Cost estimated for the last database search : 5.93 USD
Estimated total session cost : 7.31 USD

LITA - Time in minutes : 0,03
The cost estimation below is based on Questel's
standard price list

Estimated cost : 0.07 USD
Cost estimated for the last database search : 0.07 USD
Estimated total session cost : 7.38 USD

PLUSPAT - Time in minutes : 0,35
The cost estimation below is based on Questel's

standard price list
Estimated cost : 0.99 USD
Records displayed and billed : 1
Estimated cost : 1.49 USD
Cost estimated for the last database search : 2.48 USD
Estimated total session cost : 9.86 USD

Selected file: INPADOC

You are now connected to INPADOC
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For information on content, (...)INFO INPD.

Search statement 1

Query/Command : FAM US6306966/PN

1 Patent Groups

** SS 1: Results 9

Search statement 2

Query/Command : FAMSTATE NONSTOP

1/9 INPADOC - ©INPADOC

PN - AU 55989/99 A1 20010426 [AU9955989]
TI - MOISTURE CURABLE COMPOSITION
IN - HORIE YASUNOBU; EGAWA YOSHINOBU; OSHIMA YUICHI;
HASHIMUKAI HIDEHARU; WAKAUME TOMOKAZU; AOKI HIROSHI
PA - CEMEDINE CO LTD
AP - AU 55989/99-A 19991021 [1999AU-0055989]
PR - AU 55989/99-A 19991021 [1999AU-0055989]
CA 2287622/99-A 19991025 [1999CA-2287622]
EP 99121261/99-A 19991025 [1999EP-0121261]
JP 116748/98-A 19980427 [1998JP-0116748]
US 422084/99-A 19991021 [1999US-0422084]
IC - C08L-033/08; C08L-033/10; C08L-029/12; C08L-029/00; C08L-023/06; C08L-027/06; C08L-031/04

2/9 INPADOC - ©INPADOC

PN - CA 2287622 AA 20010425 [CA2287622]
TI - MOISTURE CURABLE COMPOSITION
LA - ENG
IN - HORIE YASUNOBU [JP]; HASHIMUKAI HIDEHARU [JP]; WAKAUME
TOMOKAZU [JP]; OSHIMA YUICHI [JP]; EGAWA YOSHINOBU [JP];

AOKI HIROSHI [JP]

PA - CEMEDINE CO LTD [JP]

AP - CA 2287622/99-A 19991025 [1999CA-2287622]

PR - CA 2287622/99-A 19991025 [1999CA-2287622]
 AU 55989/99-A 19991021 [1999AU-0055989]
 EP 99121261/99-A 19991025 [1999EP-0121261]
 JP 116748/98-A 19980427 [1998JP-0116748]
 US 422084/99-A 19991021 [1999US-0422084]

IC - C08L-083/06; C09J-183/06

1/1 LEGALI - ©EPO

PN - CA2287622 A1 20010425 [CA2287622]

AP - CA2287622 19991025 [1999CA-2287622]

ACTE - 20030403 CA/EEER-A [+]
 EXAMINATION REQUEST
 EFFECTIVE DATE: 20030117

UP - 2004-09

3/9 INPADOC - ©INPADOC

PN - DE 69914914 C0 20040325 [DE69914914]

TI - Feuchtigkeitshrtbare Zusammensetzung

IN - HORIE YASUNOBU [JP]; EGAWA YOSHINOBU [JP]; OSHIMA YUICHI [JP]; HASHIMUKAI HIDEHARU [JP]; WAKAUME TOMOKAZU [JP]; AOKI HIROSHI [JP]

PA - CEMEDINE CO [JP]

AP - DE 69914914/99-A 19991025 [1999DE-6014914]

PR - EP 99121261/99-A 19991025 [1999EP-0121261]

IC - C08L-043/04; C08L-071/02

1/1 LEGALI - ©EPO

PN - DE69914914 D1 20040325 [DE69914914]DE69914914 T2 20041223 [DE69914914]

AP - DE69914914 19991025 [1999DE-6014914]

ACTE - 20050317 DE/8364-A [+]
 NO OPPOSITION DURING TERM OF OPPOSITION

UP - 2005-11

4/9 INPADOC - ©INPADOC

PN - DE 69914914 T2 20041223 [DE69914914]

TI - Feuchtigkeitshrtbare Zusammensetzung

IN - HORIE YASUNOBU [JP]; EGAWA YOSHINOBU [JP]; OSHIMA YUICHI [JP]; HASHIMUKAI HIDEHARU [JP]; WAKAUME TOMOKAZU [JP]; AOKI

HIROSHI [JP]
PA - CEMEDINE CO [JP]
AP - DE 69914914/99-A 19991025 [1999DE-6014914]
PR - EP 99121261/99-A 19991025 [1999EP-0121261]
IC - C08L-043/04; C08L-071/02

1/1 LEGALI - ©EPO

PN - DE69914914 D1 20040325 [DE69914914]DE69914914 T2 20041223
 [DE69914914]
AP - DE69914914 19991025 [1999DE-6014914]
ACTE - 20050317 DE/8364-A [+]
 NO OPPOSITION DURING TERM OF OPPOSITION
UP - 2005-11

5/9 INPADOC - ©INPADOC

PN - EP 1095981 A1 20010502 [EP1095981]
TI - MOISTURE CURABLE COMPOSITION
LA - ENG
IN - HORIE YASUNOBU [JP]; EGAWA YOSHINOBU [JP]; OSHIMA YUICHI
 [JP]; HASHIMUKAI HIDEHARU [JP]; WAKAUME TOMOKAZU [JP]; AOKI
 HIROSHI [JP]
PA - CEMEDINE CO LTD [JP]
AP - EP 99121261/99-A 19991025 [1999EP-0121261]
PR - EP 99121261/99-A 19991025 [1999EP-0121261]
 AU 55989/99-A 19991021 [1999AU-0055989]
 CA 2287622/99-A 19991025 [1999CA-2287622]
 JP 116748/98-A 19980427 [1998JP-0116748]
 US 422084/99-A 19991021 [1999US-0422084]
IC - C08L-043/04; C08L-071/02
DS - BE* DE* FR* GB* IT* NL*

1/1 LEGALI - ©EPO

PN - EP1095981 A1 20010502 [EP1095981]EP1095981 B1 20040218 [EP1095981]
AP - EP99121261 19991025 [1999EP-0121261]
ACTE - 20010502 EP/AK-A [+]
 DESIGNATED CONTRACTING STATES:
 BE DE FR GB IT NL
 20010502 EP/AX-A [+]
 EXTENSION OF THE EUROPEAN PATENT TO
 AL;LT;LV;MK;RO;SI
 20010816 EP/17P-A [+]
 REQUEST FOR EXAMINATION FILED

EFFECTIVE DATE: 20010618

20020123 EP/AKX-A [+]
PAYMENT OF DESIGNATION FEES
BE DE FR GB IT NL

20030326 EP/17Q-A [+]
FIRST EXAMINATION REPORT
EFFECTIVE DATE: 20030205

20040218 EP/AK-A [+]
DESIGNATED CONTRACTING STATES:
BE DE FR GB IT NL

20040218 EP/REG-A; GB/FG4D [+]
GB: EUROPEAN PATENT GRANTED
<GB>

20040325 EP/REF-A
CORRESPONDS TO:
(DE 69914914 20040325 [DE69914914])

20041119 EP/ET-A [+]
FR: TRANSLATION FILED

20050209 EP/26N-A
NO OPPOSITION FILED
EFFECTIVE DATE: 20041119

UP - 2005-06

6/9 INPADOC - ©INPADOC

PN - EP 1095981 B1 20040218 [EP1095981]
TI - Moisture curable composition
Composition durcissable l'humidit
Feuchtigkeitshrtbare Zusammensetzung
LA - ENG
IN - HORIE YASUNOBU [JP]; EGAWA YOSHINOBU [JP]; OSHIMA YUICHI [JP]; HASHIMUKAI HIDEHARU [JP]; WAKAUME TOMOKAZU [JP]; AOKI HIROSHI [JP]
PA - CEMEDINE CO LTD [JP]
AP - EP 99121261/99-A 19991025 [1999EP-0121261]
PR - EP 99121261/99-A 19991025 [1999EP-0121261]
AU 55989/99-A 19991021 [1999AU-0055989]
CA 2287622/99-A 19991025 [1999CA-2287622]
JP 116748/98-A 19980427 [1998JP-0116748]
US 422084/99-A 19991021 [1999US-0422084]
IC - C08L-043/04; C08L-071/02
DS - BE* DE* FR* GB* IT* NL*

1/1 LEGALI - ©EPO

PN - EP1095981 A1 20010502 [EP1095981]EP1095981 B1 20040218 [EP1095981]

AP - EP99121261 19991025 [1999EP-0121261]

ACTE - 20010502 EP/AK-A [+]

DESIGNATED CONTRACTING STATES:
BE DE FR GB IT NL

20010502 EP/AX-A [+]

EXTENSION OF THE EUROPEAN PATENT TO
AL;LT;LV;MK;RO;SI

20010816 EP/17P-A [+]

REQUEST FOR EXAMINATION FILED
EFFECTIVE DATE: 20010618

20020123 EP/AKX-A [+]

PAYMENT OF DESIGNATION FEES
BE DE FR GB IT NL

20030326 EP/17Q-A [+]

FIRST EXAMINATION REPORT
EFFECTIVE DATE: 20030205

20040218 EP/AK-A [+]

DESIGNATED CONTRACTING STATES:
BE DE FR GB IT NL

20040218 EP/REG-A; GB/FG4D [+]

GB: EUROPEAN PATENT GRANTED
<GB>

20040325 EP/REF-A

CORRESPONDS TO:

(DE 69914914 20040325 [DE69914914])

20041119 EP/ET-A [+]

FR: TRANSLATION FILED

20050209 EP/26N-A

NO OPPOSITION FILED

EFFECTIVE DATE: 20041119

UP - 2005-06

7/9 INPADOC - ©INPADOC

PN - JP 3638430 B2 20050413 [JP3638430]

AP - JP 116748/98-A 19980427 [1998JP-0116748]

PR - JP 116748/98-A 19980427 [1998JP-0116748]

AU 55989/99-A 19991021 [1999AU-0055989]
CA 2287622/99-A 19991025 [1999CA-2287622]
EP 99121261/99-A 19991025 [1999EP-0121261]
US 422084/99-A 19991021 [1999US-0422084]

IC - C08L-071/02; C08K-003/36; C08K-007/16; C08L-033/04; C09J-171/02

8/9 INPADOC - ©INPADOC

PN - JP 11302527 A2 19991102 [JP11302527]
TI - MOISTURE-CURING COMPOSITION
IN - HORIE YASUNOBU; EGAWA YOSHINOBU; OSHIMA YUICHI;
HASHIMUKAI HIDEJI; WAKAUME TOMOKAZU; AOKI HIROSHI
PA - CEMEDINE CO LTD
AP - JP 116748/98-A 19980427 [1998JP-0116748]
PR - JP 116748/98-A 19980427 [1998JP-0116748]
AU 55989/99-A 19991021 [1999AU-0055989]
CA 2287622/99-A 19991025 [1999CA-2287622]
EP 99121261/99-A 19991025 [1999EP-0121261]
US 422084/99-A 19991021 [1999US-0422084]
IC - C08L-071/00; C08K-003/36; C08K-007/16; C08L-033/04

9/9 INPADOC - ©INPADOC

PN - US 6306966 BA 20011023 [US6306966]
TI - MOISTURE CURABLE COMPOSITION
IN - HORIE YASUNOBU [JP]; EGAWA YOSHINOBU [JP]; OSHIMA YUICHI
[JP]; HASHIMUKAI HIDEHARU [JP]; WAKAUME TOMOKAZU [JP]; AOKI
HIROSHI [JP]
PA - CEMEDINE CO LTD [US]
AP - US 422084/99-A 19991021 [1999US-0422084]
PR - US 422084/99-A 19991021 [1999US-0422084]
AU 55989/99-A 19991021 [1999AU-0055989]
CA 2287622/99-A 19991025 [1999CA-2287622]
EP 99121261/99-A 19991025 [1999EP-0121261]
JP 116748/98-A 19980427 [1998JP-0116748]
IC - C08L-071/02

1/1 LEGAL - ©EPO

PN - US6306966 B1 20011023 [US6306966]
AP - US42208499 19991021 [1999US-0422084]
ACTE - 19991021 US/AS-A
ASSIGNMENT
OWNER: CEMEDINE CO., LTD. 5-9, HIGASHIGOTANDA 4-CHOME SHI
ASSIGNMENT OF ASSIGNORS INTEREST;ASSIGNORS:HORIE,
YASUNOBU;EGAWA, YOSHINOBU;OSHIMA, YUICHI;AND
OTHERS;REEL/FRAME:010338/0459;SIGNING DATES FROM 19991012 TO

19991014

20040615 US/RF-A
REISSUE APPLICATION FILED
EFFECTIVE DATE: 20031023

UP - 2004-26

Search statement 2

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Patent Search - Number: 6306966

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PATNO IS 6306966

DATE: JANUARY 20, 2006
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FILE: ALL

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PATNO IS 6306966

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LEVEL 1... 1

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To MODIFY your search request, press the M key (for MODIFY) and then the ENTER key.

For further explanation, press the H key (for HELP) and then the ENTER key.

LEVEL 1 - 1 PATENT

1. 6306966 , October 23, 2001 , Moisture curable composition, Horie, Yasunobu - Tokyo, Japan (JP); Egawa, Yoshinobu - Tokyo, Japan (JP); Oshima, Yuichi - Tokyo, Japan (JP); Hashimukai, Hideharu - Tokyo, Japan (JP); Wakaume, Tomokazu - Tokyo, Japan (JP); Aoki, Hiroshi - Tokyo, Japan (JP), 422084 (09), Cemedine Co., Ltd., Tokyo, Japan (JP), 03, October 21, 1999 - ASSIGNMENT OF ASSIGNEES INTEREST (SEE DOCUMENT FOR DETAILS)., CEMEDINE CO., LTD. 5-9, HIGASHIGOTANDA 4-CHOME SHINAGAWA-KU, TOKYO JAPAN, Reel and Frame Number: 10338/0459

CORE TERMS: powder, composition, adhesive, refractive index, transparency, amorphous, blending, mixture, polymer, curable ...

LEVEL 1 - 1 OF 1 PATENT

UNITED STATES PATENT AND TRADEMARK OFFICE GRANTED PATENT

6306966

October 23, 2001

Moisture curable composition

REISSUE: October 23, 2003 - Reissue Application filed Ex. Gp.: 1712; Re. S.N. 10/691,433 (O.G. June 15, 2004)

APPL-NO: 422084 (09)

FILED-DATE: October 21, 1999

GRANTED-DATE: October 23, 2001

CORE TERMS: powder, composition, adhesive, refractive index, transparency, amorphous, blending, mixture, polymer, curable ...

6306966 OR 6,306,966

Your search request has found no CASES.

To edit the above request, use the arrow keys. Be sure to move the cursor to the end of the request before you enter it.

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Patent Search - Number: 6306966

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